

RoHS

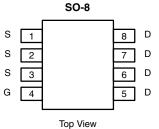
COMPLIANT HALOGEN

FREE Available

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
30	0.014 at V _{GS} = 10 V	14	7.3 nC			
	0.0175 at V _{GS} = 4.5 V	12.5	7.5 110			

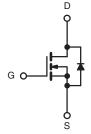


FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested ٠
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Conversion
- Notebook System Power



N-Channel MOSFET

Ordering Information: Si4134DY-T1-E3 (Lead (Pb)-free) Si4134DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \degree C$, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		14		
Continuous Drain Current (T. -150 °C)	T _C = 70 °C	- I _D	11.2		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		9.9 ^{b, c}		
	T _A = 70 °C		7.9 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	32	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		4.1		
	T _A = 25 °C	- I _S	2.0 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	15		
Avalanche Energy	L = 0.1 mH	E _{AS}	11.25	mJ	
	T _C = 25 °C	– P _D	5		
Maximum Power Dissipation	T _C = 70 °C		3.2	w	
	T _A = 25 °C		2.5 ^{b, c}	VV	
	T _A = 70 °C	1	1.6 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Typical Maximum		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	25	0/10	

Notes: a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

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Si4134DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•		•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 vA		33		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.0			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2	1.8	2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	- μΑ	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	20			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A		0.0115	0.014	Ω	
		V _{GS} = 4.5 V, I _D = 7 A		0.0145	0.0175		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		24		S	
Dynamic ^b		•		•			
Input Capacitance	C _{iss}			846			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		187		pF	
Reverse Transfer Capacitance	C _{rss}			72			
Total Gate Charge	Q _g -	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		15.4	23	nC	
		20 00 2		7.3	11		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		2.3			
Gate-Drain Charge	Q _{gd}			2.2			
Gate Resistance	Rg	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t _{d(on)}			15	30		
Rise Time	t _r	V _{DD} = 15 V, R _I = 1.5 Ω		12	24	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		13	26		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			9	18		
Rise Time	t _r	V _{DD} = 15 V, R _L = 1.5 Ω		9	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		14	28		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characteristi	cs			I	I		
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			4.2		
Pulse Diode Forward Current ^a	I _{SM}				32	A	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.78	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		17	34	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			9.5	19	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		10	-	- ns	
Reverse Recovery Rise Time	t _b	4		7			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

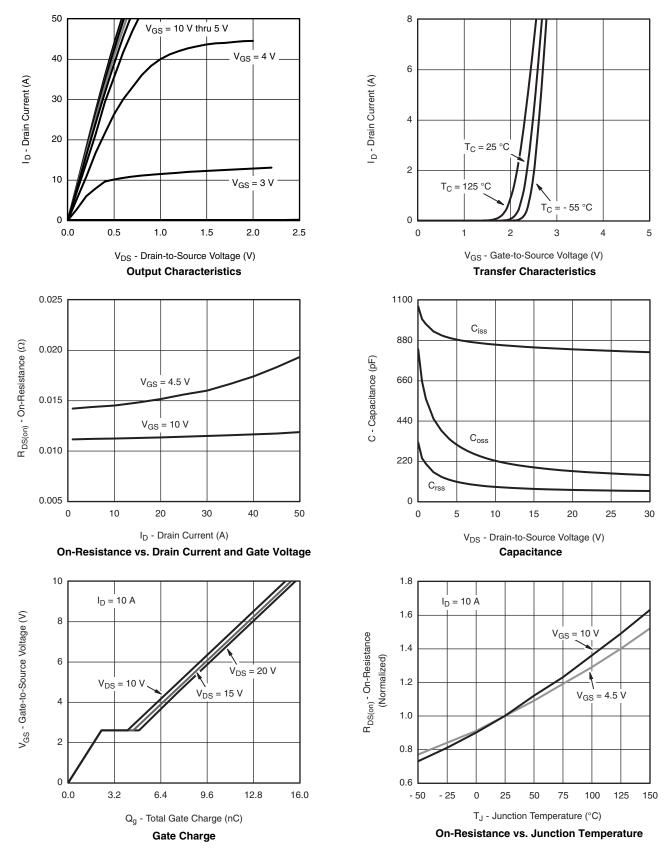
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Si4134DY Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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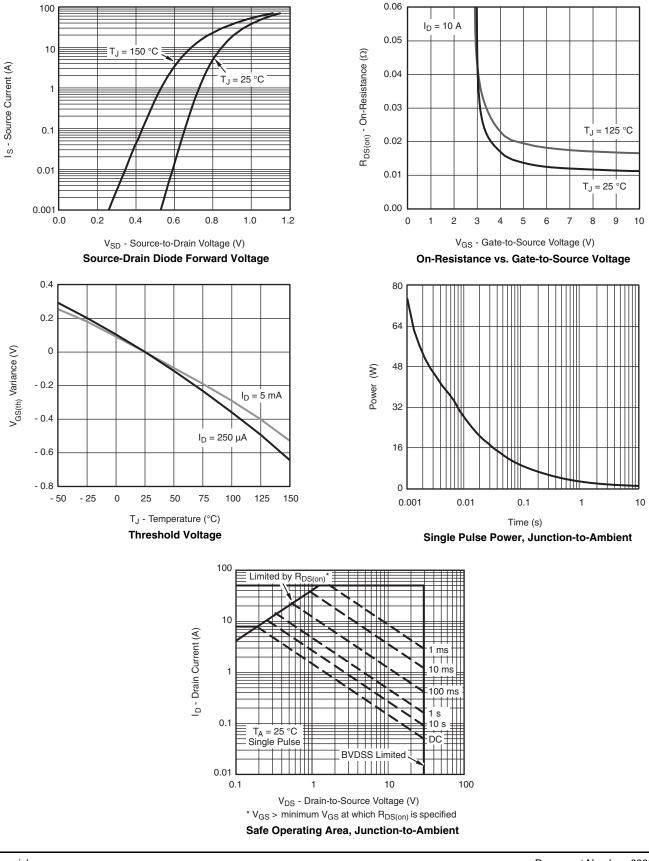
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Si4134DY

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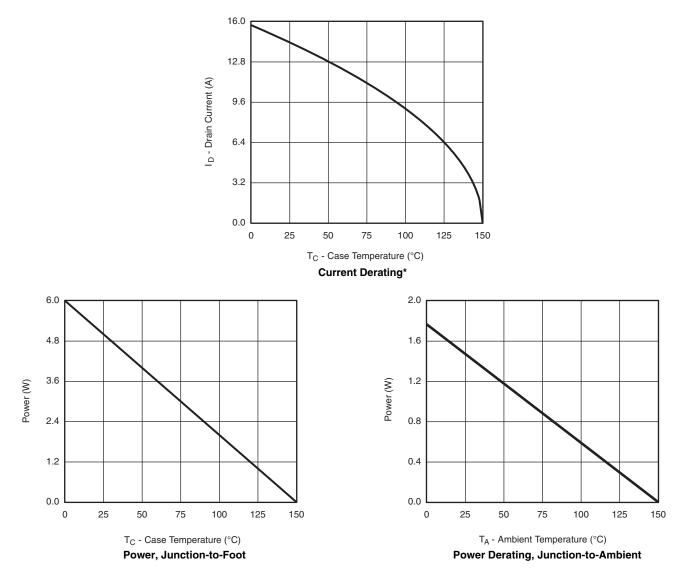


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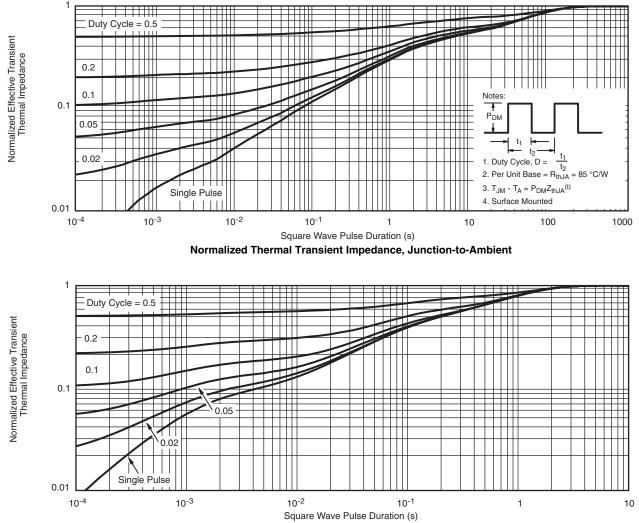


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?68999</u>.

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